# **Not Recommended for New Designs**



# 48 Volt PI31xx-0x-HVIZ



# 48V<sub>IN</sub> and 3.3 – 18V<sub>OUT</sub>, ZVS Isolated DC-DC Converter Modules

#### **Product Description**

The ZVS Isolated Converter Module Series consists of high-density isolated DC-DC converters implementing Zero-Voltage Switching topology.

The  $48V_{\rm IN}$  series operates over a wide input range of  $36-75{\rm V}$  with 3.3V and 12V output models and a narrower range of  $41-57{\rm V}$  at 18V output for PoE and other applications. Both model sets produce 60W of output power, yeilding an unprecedented power density of  $400{\rm W/in}^3$ .

Device	Ou	I May	
Device	Set	Range	I <sub>OUT</sub> Max
PI3101-00-HVIZ	3.3V	2.97 – 3.63V	18A
PI3105-00-HVIZ	12V	9.6 – 13.2V	5A
PI3110-01-HVIZ	18V	16.2 – 19.8V	3.3A

These converter modules are surface mountable and only ~0.5in square in area achieving ~50% space reduction versus conventional solutions.

A switching frequency of 900kHz allows for small input and output filter components which further reduces the total size and cost of the overall system solution. The output voltage is sensed and fed back to the internal controller using a proprietary isolated magnetic feedback scheme which allows for high bandwidth and good common mode noise immunity.

The 48 Volt PI31xx series requires no external feedback compensation and offers a total solution with a minimum number of external components. A rich feature set is offered, including output voltage trim capability, output overvoltage protection, adjustable soft start, overcurrent protection with auto-restart, over and under input voltage lockout and a temperature monitoring and protection function that provides an analog voltage proportional to the die temperature as shut down and alarm capabilities.

#### **Features & Benefits**

- Efficiency up to 89%
- High switching frequency minimizes input filter requirements and reduces output capacitance
- Proprietary "Double-Clamped" ZVS Buck-Boost Topology
- Proprietary isolated magnetic feedback
- Small footprint (0.57in<sup>2</sup>) enables PCB area savings
- Very low profile (0.265in)
- On/Off Control, positive logic
- Wide trim range +10/-20% for PI3105-00-HVIZ (+10/-10% for other models)
- Temperature Monitor (TM) & Overtemperature Protection (OTP)
- Input UVLO & OVLO and output OVP
- Overcurrent protection with auto restart
- Adjustable soft start
- 2250V<sub>DC</sub> input-to-output isolation

## **Applications**

- Space-Constrained Systems
- Isolated Board-Level Power
- Network Power Systems
- Telecommunications
- Distributed Power Architecture
- PoE Power Over Ethernet
- IPoL Isolated Point-of-Load Power

#### **Package Information**

- Surface Mountable 0.87 x 0.65 x 0.265in package
- Weight = 7.8 grams





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# **Order Information**

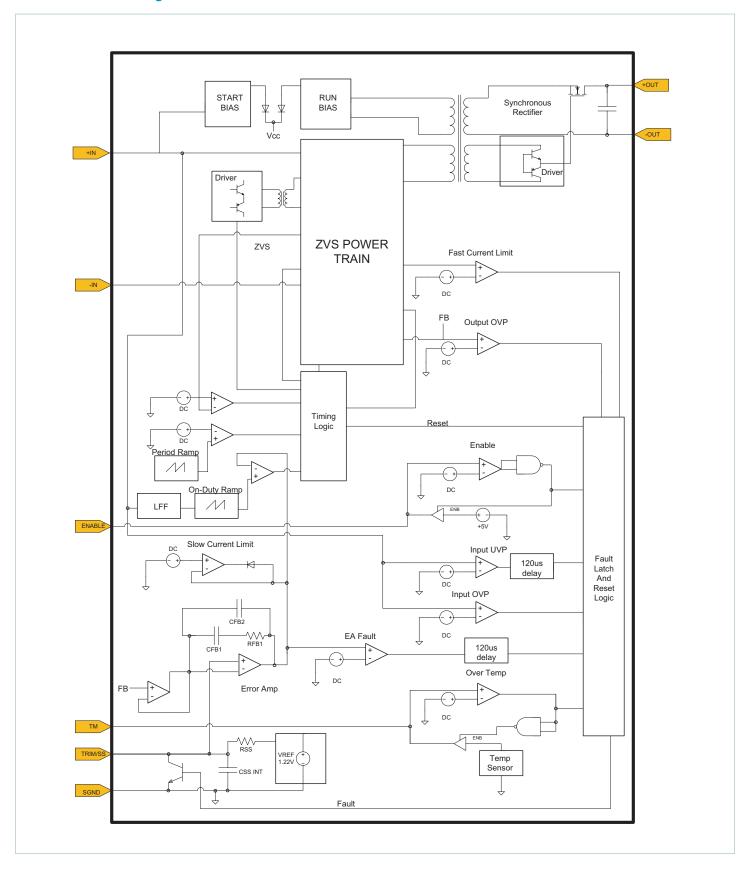
Part Number	V <sub>IN</sub>	V <sub>OUT</sub>	I <sub>OUT</sub> Max	Package	Transport Media
PI3101-00-HVIZ	36 – 75V	3.3V	18A	0.87 x 0.65 x 0.265in	TRAY
PI3105-00-HVIZ	36 – 75V	12V	5A	0.87 x 0.65 x 0.265in	TRAY
PI3110-01-HVIZ	41 – 57V	18V	3.3A	0.87 x 0.65 x 0.265in	TRAY
		Δ	Also Available		
PI3109-01-HVIZ	18 – 36V	5V	10A	0.87 x 0.65 x 0.265in	TRAY
PI3106-01-HVIZ	18 – 36V	12V	4.2A	0.87 x 0.65 x 0.265in	TRAY
PI3108-00-HVMZ	16 – 50V	3.3V	10A	0.87 x 0.65 x 0.265in	TRAY
PI3109-00-HVMZ	16 – 50V	5V	10A	0.87 x 0.65 x 0.265in	TRAY
PI3106-00-HVMZ	16 – 50V	12V	4.2A	0.87 x 0.65 x 0.265in	TRAY
PI3111-00-HVMZ	16 – 50V	15V	3.33A	0.87 x 0.65 x 0.265in	TRAY

# **Absolute Maximum Ratings**

Name	Rating	
+IN to –IN Max Operating Voltage	<b>PI3101-00-HVIZ / PI3105-00-HVIZ</b> –1.0 to 75V <sub>DC</sub> (operating)	<b>PI3110-01-HVIZ</b> –1.0 to 57V <sub>DC</sub> (operating)
+IN to −IN Max Peak Voltage	<b>PI3101-00-HVIZ / PI3105-00-HVIZ</b> 100V <sub>DC</sub> (non-operating, 100ms)	PI3110-01-HVIZ 80V <sub>DC</sub> (non-operating, 100ms)
ENABLE to -IN	–0.3 to 6.0V <sub>DC</sub>	
TM to -IN	-0.3 to 6.0V <sub>DC</sub>	
TRIM/SS to -IN	-0.3 to 6.0V <sub>DC</sub>	
+OUT to -OUT	See relevant model output section	
Isolation Voltage (+IN/–IN to +OUT/–OUT)	2250V <sub>DC</sub>	
Continuous Output Current	See relevant model output section	
Peak Output Current	See relevant model output section	
Operating Junction Temperature	−40 to 125°C	
Storage Temperature	−50 to 125°C	
Case Temperature During Reflow	245°C	
Peak Compressive Force Applied to Case (Z-axis)	3lbs (supported by J-lead only)	



## **Functional Block Diagram**



## **Pin Description**

Pin Name	Description
+IN	Primary side positive input voltage terminals.
-IN	Primary side negative input voltage terminals.
ENABLE	Converter enable option, functions as 5V reference and on / off control pin. Pull low for off.
TRIM/SS	External soft-start pin and trim function. Connect to SGND or ENABLE through resistor for trim up or trim down.
TM	Temperature measurement output pin.
SGND	Signal ground, primary side referenced.
+OUT	Isolated secondary DC output voltage positive terminals.
-OUT	Isolated secondary DC output voltage negative terminals.

# **Package Pinout**



## **PI3101-00-HVIZ Electrical Characteristics**

Unless otherwise specified: 36V <  $V_{IN}$  < 75V, 0A <  $I_{OUT}$  < 18A,  $-40^{\circ}$ C <  $T_{CASE}$  < 100°C  $^{[a]}$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V <sub>IN</sub>	input specifications	36	48	75	\/
Input dV/dt [a]		V <sub>IN</sub> = 75V	30	40	1.0	V <sub>DC</sub> V/µs
Input Undervoltage Turn-on	V <sub>INDVDT</sub> V <sub>UVON</sub>	$I_{O} = 1.8A$	32.5	34.0	35.0	V <sub>DC</sub>
Input Undervoltage Turn-off	V <sub>UVOFF</sub>	$I_0 = 1.8A$	30.5	32.0	33.0	V <sub>DC</sub>
Input Undervoltage Hysteresis	V <sub>UVOFF</sub>	$I_0 = 1.8A$	30.3	2	33.0	V <sub>DC</sub>
Input Overvoltage Turn-on			75.7	78	81.0	
Input Overvoltage Turn-off	V <sub>OVON</sub>	$I_0 = 1.8A$	77.7	80.0	82.3	V <sub>DC</sub>
Input Overvoltage Hysteresis	V <sub>OVOFF</sub>	I <sub>O</sub> = 1.8A	77.7		02.3	V <sub>DC</sub>
	V <sub>OVH</sub>	$I_0 = 1.8A$		1.6		V <sub>DC</sub>
Input Quiescent Current	IQ	$V_{IN} = 48V$ , ENABLE = 0V		2.5		mA <sub>DC</sub>
Input Idling Power	P <sub>IDLE</sub>	$V_{IN} = 48V$ , $I_{OUT} = 0A$		4		W
Input Standby Power	P <sub>SBY</sub>	$V_{IN} = 48V$ , ENABLE = 0V		0.120		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE}$ = 100°C, $I_{OUT}$ = 18A, $\eta_{FL}$ = 86.5% typical, $V_{IN}$ = 48V		1.43		$A_{DC}$
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{\text{IN}} = 2 \mu \text{H C}_{\text{IN}} = 47 \mu \text{F}$ 100V electrolytic + 2 x 1 $\mu \text{F}$ 100V X7R ceramic		10		mApp
Recommended Ext Input Capacitance	$C_IN$	$C_{IN}$ = 47 $\mu$ F 100V electrolytic + 2 x 1 $\mu$ F 100V X7R ceramic $C_{IN}$ = Cbulk + Chf		49		μF
		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 9A		3.3		V <sub>DC</sub>
		-0°C < T <sub>CASE</sub> < 100°C	-3		+3	%
Total Output Accuracy	$V_{OA}$	-40°C < T <sub>CASE</sub> < 0°C	-4		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>	0.02	-10		10	%
Output Current Range	I <sub>OUT</sub>				18	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		18.8	26	34	A <sub>DC</sub>
Efficiency – Full Load	η <sub>FI</sub>	$T_{CASE} = 100^{\circ}C, V_{IN} = 48V$	84.5	86.5		%
Efficiency – Half Load	η <sub>HL</sub>	$T_{CASE} = 100^{\circ}C$ , $V_{IN} = 48V$		84.5		%
Output OVP Set Point	V <sub>OVP</sub>	CASE 7 IIV	3.9	4.1	4.3	V <sub>DC</sub>
Output Ripple Voltage	V <sub>ORPP</sub>	C <sub>OUT</sub> = 12 x 10μF 10V X7R DC-20MHz		75		mVpp
Switching Frequency	f <sub>SW</sub>	-001		900		kHz
Output Turn-on Delay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{UVON}$ to ENABLE = 5V		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	$V_{IN} = V_{UVOFF}$ to ENABLE < 1.8V		10		μs
Soft-Start Ramp Time	t <sub>SS</sub>	ENABLE = 5V to 90% V <sub>OUT</sub> C <sub>REF</sub> = 0		230		μs
Maximum Load Capacitance	C <sub>OUT</sub>	$C_{REF} = 1 \mu F$ , $C_{OUT} = Al$ Electrolytic		250	10000	μF
Load Transient Deviation	V <sub>ODV</sub>	$I_{OUT} = 25\%$ step 0.1A/ $\mu$ S $C_{OUT} = 12 \times 10\mu$ F 10V X7R		75		mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 12 \times 10 \mu 10 V \times 7R$ $I_{OUT} = 25\% \text{ step } 0.1 \text{A}/\mu\text{S}$ $C_{OUT} = 12 \times 10 \mu\text{F } 10 \text{V } \times 7R$ $V_{OUT} \le 1\%$		120		μs
Maximum Output Power	P <sub>OUT</sub>			60		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 4.5V <sub>DC</sub>				
Continuous Output Current		18A <sub>DC</sub>				
Peak Output Current		34A <sub>DC</sub>				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature. <sup>[b]</sup> Current flow sourced by a pin has a negative sign.



# PI3101-00-HVIZ Electrical Characteristics (Cont.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		FNARIE				
DC Valta as Dafarra as Outsut	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	ENABLE	4.65	4.0	F 1F	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
DC Voltage Reference Output	V <sub>ERO</sub>	ENABLE 2 2V	4.65	4.9	5.15	V <sub>DC</sub>
Output Current Limit [b]	I <sub>ECL</sub>	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA <sub>DC</sub>
Start Up Current Limit [b]	I <sub>ESL</sub>	ENABLE = 1V	-120	-90	-60	μΑ
Module Enable Voltage	V <sub>EME</sub>		1.95	2.5	3.05	V <sub>DC</sub>
Module Disable Voltage	V <sub>EMD</sub>		1.8	2.35	2.9	V <sub>DC</sub>
Disable Hysteresis	V <sub>EDH</sub>			150		mV
Enable Delay Time	t <sub>EE</sub>			10		μs
Disable Delay Time	t <sub>ED</sub>			10		μs
Maximum Capacitance	C <sub>EC</sub>				1500	pF
Maximum External Toggle Rate	f <sub>EXT</sub>				1	Hz
		TRIM/SS				
Trim Voltage Reference	V <sub>REF</sub>			1.22		V <sub>DC</sub>
Internal Capacitance	C <sub>REFI</sub>			10		nF
External Capacitance	C <sub>REF</sub>				1	μF
Internal Resistance	R <sub>REFI</sub>			10		kΩ
	- KEN					
		TM (Temperature Monitor)	,	ı		
Temperature Coefficient [a]	TM <sub>TC</sub>			10		mV/°K
Temperature Full Range Accuracy [a]	TM <sub>ACC</sub>		-5		5	°K
Drive Capability	I <sub>TM</sub>		-100			μΑ
TM Output Setting	V <sub>TM</sub>	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [a]	T <sub>MAX</sub>		130	135	140	°C
Junction-to-Case Thermal Impedance	θ <sub>J-C</sub>			3		°C/W
Case-to-Ambient Thermal Impedance	θ <sub>C-A</sub>	Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C		8.6		°C/W
cuse to / implent memai impedance	oc-A			0.0		C,
	,	Soldering	,			
Peak Temperature During Reflow		MSL 5; time on floor = 48 hours			225	°C
Teak lemperature burning henow		MSL 6; time on floor = 4 hours			245	°C
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07	1	Fact action UTTI FFLISE New -2 Series Fire	Α		10	Α.
Recommended Input Fuse Rating	I <sub>FUSE</sub>	Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse	4		10	А

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



### PI3101-00-HVIZ Electrical Characteristics (Cont.)

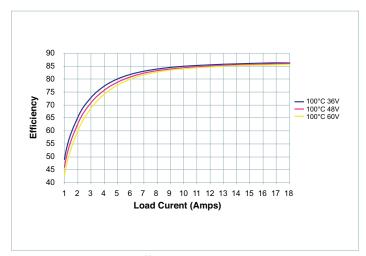


Figure 1 — Conversion efficiency

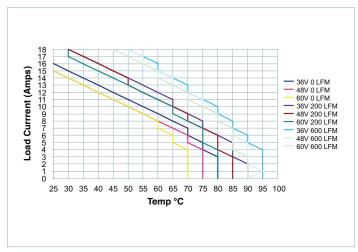


Figure 2 — Load currrent vs. temperature (without heat sink)

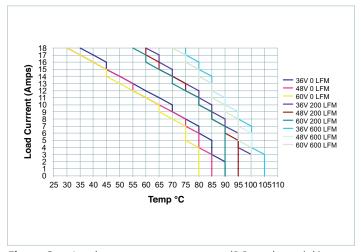
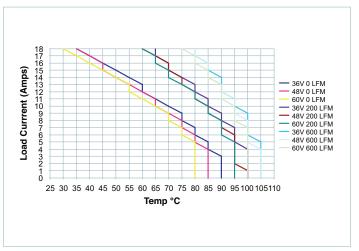
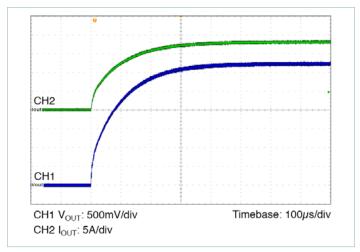


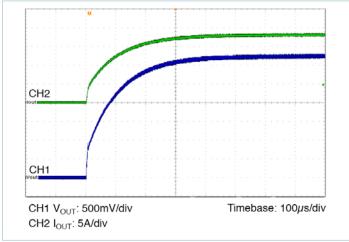
Figure 3 — Load currrent vs. temperature (6.3mm heat sink)



**Figure 4** — Load currrent vs. ambient temperature (11mm heat sink)

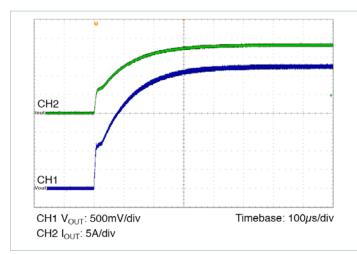


**Figure 5** — Start up  $C_{REF} = 0$  ( $V_{IN} = 36V$ ,  $I_{OUT} = 18A$ , CR,  $C_{OUT} = 12 \times 10 \mu F X7R$  ceramic)

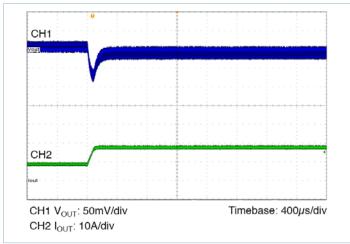


**Figure 6** — Start up  $C_{REF} = 0$  ( $V_{IN} = 48V$ ,  $I_{OUT} = 18A$ , CR,  $C_{OUT} = 12 \times 10 \mu F X7R$  ceramic)

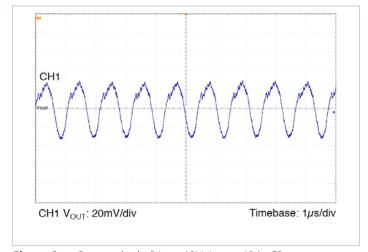
## PI3101-00-HVIZ Electrical Characteristics (Cont.)



**Figure 7** — Start up  $C_{REF} = 0$  ( $V_{IN} = 75V$ ,  $I_{OUT} = 18A$ , CR,  $C_{OUT} = 12 \times 10 \mu F X7R$  ceramic)



**Figure 8** — Transient response ( $V_{IN} = 48V$ ,  $I_{OUT} = 9 - 18A$ ,  $0.1A/\mu$ s,  $C_{OUT} = 12 \times 10\mu$ F X7R ceramic)



**Figure 9** — Output ripple ( $V_{IN} = 48V$ ,  $I_{OUT} = 18A$ , CR,  $C_{OUT} = 12 \times 10 \mu F X7R$  ceramic)



**Figure 10** — Thermal image ( $V_{IN}$  = 48V,  $I_{OUT}$  = 18A, CR, OLFM evaluation PCB)

## **PI3105-00-HVIZ Electrical Characteristics**

Unless otherwise specified: 36V <  $V_{IN}$  < 75V, 0A <  $I_{OUT}$  < 5A,  $-40^{\circ}C$  <  $T_{CASE}$  < 100°C  $^{[a]}$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Innut Englishme				
In rout Valta as Danas	\ /	Input Specifications	26	40	75	1/
Input Voltage Range	V <sub>IN</sub>	) / JEN	36	48	75	V <sub>DC</sub>
Input dV/dt [a]	V <sub>INDVDT</sub>	V <sub>IN</sub> = 75V	20.5	2.0	1.0	V/µs
Input Undervoltage Turn-on	V <sub>UVON</sub>	$I_0 = 5A$	32.5	34.0	35.0	$V_{DC}$
Input Undervoltage Turn-off	$V_{UVOFF}$	I <sub>0</sub> = 5A	30.5	31.5	33	$V_{DC}$
Input Undervoltage Hysteresis	V <sub>UVH</sub>	$I_0 = 5A$		2.5		V <sub>DC</sub>
Input Overvoltage Turn-on	V <sub>OVON</sub>	$I_0 = 5A$	75.7	78	81.0	V <sub>DC</sub>
Input Overvoltage Turn-off	$V_{OVOFF}$	$I_0 = 5A$	77.7	80	82.3	$V_{DC}$
Input Overvoltage Hysteresis	$V_{OVH}$	$I_0 = 5A$		2		$V_{DC}$
Input Quiescent Current	$I_Q$	V <sub>IN</sub> = 48V, ENABLE = 0V		2.5		$mA_{DC}$
Input Idling Power	$P_{IDLE}$	$V_{IN} = 48V$ , $I_{OUT} = 0A$		4.1		W
Input Standby Power	$P_{SBY}$	$V_{IN} = 48V$ , ENABLE = $0V$		0.120		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE}$ = 100°C, $I_{OUT}$ = 5A, $\eta_{FL}$ = 88.5% typical, $V_{IN}$ = 48V		1.412		A <sub>DC</sub>
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{IN}$ = 2 $\mu$ H C $_{IN}$ = 47 $\mu$ F 100V electrolytic + 2 x 1 $\mu$ F 100V X7R ceramic		10		mApp
Recommended Ext Input Capacitance	$C_IN$	$C_{IN}$ = 47 $\mu$ F 100V electrolytic + 2 x 1 $\mu$ F 100V X7R ceramic $C_{IN}$ = Cbulk + Chf		49		μF
		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 2.5A		12.0		$V_{DC}$
		$-0^{\circ}\text{C} < \text{T}_{CASF} < 100^{\circ}\text{C}$	-3		+3	%
Total Output Accuracy	$V_{OA}$	-40°C < T <sub>CASE</sub> < 0°C	-4		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>	CASE	-20		10	%
Output Current Range	I <sub>OUT</sub>				5	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		5.5	7.9	10	A <sub>DC</sub>
Efficiency – Full Load	$\eta_{FL}$	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 48V	86.5	88.5		%
Efficiency – Half Load	$\eta_{HL}$	$T_{CASE} = 100^{\circ}C$ , $V_{IN} = 48V$	84.0	86.0		%
Output OVP Set Point	V <sub>OVP</sub>	CASE 100 C, TIIN 101	13.8	14.5	15.3	V <sub>DC</sub>
Output Ripple Voltage	VOVP	C <sub>OUT</sub> = 6 x 4.7μF 16V X7R DC-20MHz	13.0	175	13.3	mVpp
Switching Frequency		C <sub>0UT</sub> = 0 x 4.7 μι 10 v X7 κ DC-20 ινι 12		900		kHz
	f <sub>SW</sub>	\\ \\ +0 ENIADIE E\\				
Output Turn off Dolay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{UVON}$ to ENABLE = 5V		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	$V_{IN} = V_{UVOFF}$ to ENABLE < 1.8V		10		μs
Soft-Start Ramp Time	t <sub>SS</sub>	ENABLE = 5V to 90% V <sub>OUT</sub> C <sub>REF</sub> = 0		230	4200	μs
Maximum Load Capacitance	C <sub>OUT</sub>	$C_{REF} = 0.22 \mu F$ , $C_{OUT} = Al$ Electrolytic			1200	μF
Load Transient Deviation	V <sub>ODV</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 4.7 \mu$ F 16V X7R		220		mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 4.7 \mu$ F 16V X7R $V_{OUT} \le 1\%$		120		μs
Maximum Output Power	P <sub>OUT</sub>			60		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 16V <sub>DC</sub>				
Continuous Output Current		5A <sub>DC</sub>				
Peak Output Current		10A <sub>DC</sub>				
Those parameters are not production		- υς				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



# PI3105-00-HVIZ Electrical Characteristics (Cont.)

ENABLE  DC Voltage Reference Output  Output Current Limit [b]  Start Up Current Limit [b]  Module Enable Voltage  Vent  Module Disable Voltage  Vent  Nemb  Disable Hysteresis  Enable Delay Time  Ue  Ue  Maximum Capacitance  Cec  Maximum External Toggle Rate  Fext  TRIM/SS  Trim Voltage Reference  Internal Capacitance  Cec  Internal Capacitance  Refer  External Capacitance  Refer  Internal Resistance  Refer  Tmyc Capability  Tmyc Capability  Tmy Output Setting  Vent  Thermal Specification  Junction Temperature Shutdown [a]  Junction-to-Case Thermal Impedance  Case-to-Ambient Thermal Impedance  Toket  Soldering  Maximum External Impedance  Output Setting  Vent  ENABLE  EN	4.65 -3.3 -120 1.95 1.8	4.9 -2.6 -90 2.5 2.35 150 10 10 1.235 10	5.15 -1.9 -60 3.05 2.9 1500 1	V <sub>DC</sub> mA <sub>DC</sub> μA V <sub>DC</sub> V <sub>DC</sub> mV μs μs pF Hz  V <sub>DC</sub> nF μF
DC Voltage Reference Output         V <sub>ERO</sub> Output Current Limit <sup>[b]</sup> I <sub>ECL</sub> ENABLE = 3.3V           Start Up Current Limit <sup>[b]</sup> I <sub>ESL</sub> ENABLE = 1V           Module Enable Voltage         V <sub>EME</sub> Module Disable Voltage         V <sub>EMD</sub> Disable Hysteresis         V <sub>EDH</sub> Enable Delay Time         I <sub>EE</sub> Maximum Capacitance         C <sub>EC</sub> Maximum External Toggle Rate         f <sub>EXT</sub> TRIM/SS           Trim Voltage Reference         V <sub>REF</sub> Internal Capacitance         C <sub>REF</sub> External Capacitance         C <sub>REF</sub> Internal Resistance         R <sub>REFI</sub> Internal Resistance         TM (Temperature Monitor)           Temperature Coefficient [a]         TM <sub>TC</sub> Temperature Full Range Accuracy [a]         TM <sub>ACC</sub> Drive Capability         I <sub>TM</sub> TM Output Setting         V <sub>TM</sub> Ambient Temperature = 300°K           Thermal Specification           Junction Temperature Shutdown [a]         T <sub>MAX</sub> Junction-to-Case Thermal Impedance         Θ <sub>L-C</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	-3.3 -120 1.95 1.8	-2.6 -90 2.5 2.35 150 10 10	-1.9 -60 3.05 2.9	mA <sub>DC</sub> μA V <sub>DC</sub> V <sub>DC</sub> mV μs μs pF Hz  V <sub>DC</sub> nF
Output Current Limit [b]         I <sub>ECL</sub> ENABLE = 3.3V           Start Up Current Limit [b]         I <sub>ESL</sub> ENABLE = 1V           Module Enable Voltage         V <sub>EME</sub> Module Disable Voltage         V <sub>EMD</sub> Disable Hysteresis         V <sub>EDH</sub> Enable Delay Time         t <sub>EE</sub> Disable Delay Time         t <sub>ED</sub> Maximum Capacitance         C <sub>EC</sub> Maximum External Toggle Rate         f <sub>EXT</sub> Internal Capacitance         V <sub>REF</sub> Internal Capacitance         C <sub>REF</sub> External Capacitance         C <sub>REF</sub> External Resistance         R <sub>REFI</sub> Internal Resistance         TM <sub>TC</sub> Temperature Coefficient [a]         TM <sub>TC</sub> Temperature Full Range Accuracy [a]         TM <sub>ACC</sub> Drive Capability         I <sub>TM</sub> TM Output Setting         V <sub>TM</sub> Ambient Temperature = 300°K           Junction-to-Case Thermal Impedance         θ <sub>J-C</sub> Gase-to-Ambient Thermal Impedance         θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	-3.3 -120 1.95 1.8	-2.6 -90 2.5 2.35 150 10 10	-1.9 -60 3.05 2.9	mA <sub>DC</sub> μA V <sub>DC</sub> V <sub>DC</sub> mV μs μs pF Hz  V <sub>DC</sub> nF
Start Up Current Limit (b)  Module Enable Voltage  VeME  Module Disable Voltage  VeMD  Disable Hysteresis  VeDH  Disable Delay Time  Disable Delay Time  Maximum Capacitance  Maximum External Toggle Rate  TRIM/SS  Trim Voltage Reference  Internal Capacitance  CREF  External Capacitance  RREF  Internal Resistance  RREF  Internal Resistance  TM (Temperature Monitor)  Temperature Coefficient (a)  Time Capability  Thermal Specification  Junction Temperature Shutdown (a)  Junction Temperature Shutdown (a)  Junction-to-Case Thermal Impedance  Obc A  Mounted on 9in² 1oz. Cu 6 layer PCB 25°C  Soldering	-120 1.95 1.8		-60 3.05 2.9 1500	μA  V <sub>DC</sub> V <sub>DC</sub> mV  μs  μs  pF  Hz  V <sub>DC</sub> nF
Module Enable Voltage       V <sub>EMD</sub> Module Disable Voltage       V <sub>EMD</sub> Disable Hysteresis       V <sub>EDH</sub> Enable Delay Time       t <sub>EE</sub> Disable Delay Time       t <sub>ED</sub> Maximum Capacitance       C <sub>EC</sub> Maximum External Toggle Rate       f <sub>EXT</sub> TRIM/SS         TRIM/SS         Trim Voltage Reference         Internal Capacitance       C <sub>REF</sub> External Capacitance       C <sub>REF</sub> Internal Resistance       R <sub>REFI</sub> Internal Resistance       TM <sub>TC</sub> Temperature Coefficient [a]       TM <sub>TC</sub> Temperature Full Range Accuracy [a]       TM <sub>ACC</sub> Drive Capability       I <sub>TM</sub> TM Output Setting       V <sub>TM</sub> Ambient Temperature = 300°K         Thermal Specification         Junction Temperature Shutdown [a]       T <sub>MAX</sub> Junction-to-Case Thermal Impedance       Θ <sub>F-C</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C         Case-to-Ambient Thermal Impedance       Θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	1.95	2.5 2.35 150 10 10 1.235 10	3.05 2.9 1500 1	VDC VDC MV
Module Disable Voltage     V <sub>EMD</sub> Disable Hysteresis     V <sub>EDH</sub> Enable Delay Time     t <sub>EE</sub> Disable Delay Time     t <sub>ED</sub> Maximum Capacitance     C <sub>EC</sub> Maximum External Toggle Rate     f <sub>EXT</sub> TRIM/SS       Trim Voltage Reference     V <sub>REF</sub> Internal Capacitance     C <sub>REF</sub> External Capacitance     C <sub>REF</sub> Internal Resistance     R <sub>REFI</sub> Temperature Coefficient [a]     TM <sub>TC</sub> Temperature Full Range Accuracy [a]     TM <sub>ACC</sub> Drive Capability     I <sub>TM</sub> TM Output Setting     V <sub>TM</sub> Ambient Temperature = 300°K       Thermal Specification       Junction Temperature Shutdown [a]     T <sub>MAX</sub> Junction-to-Case Thermal Impedance     θ <sub>J-C</sub> Case-to-Ambient Thermal Impedance     θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	1.8	2.35 150 10 10 10 1.235 10	2.9 1500 1	V <sub>DC</sub> mV  µs  µs  pF  Hz  V <sub>DC</sub> nF  µF
Disable Hysteresis         V <sub>EDH</sub> Enable Delay Time         t <sub>EE</sub> Disable Delay Time         t <sub>ED</sub> Maximum Capacitance         C <sub>EC</sub> Maximum External Toggle Rate         f <sub>EXT</sub> TRIM/SS           TRIM/SS           TRIM/SS           TRIM/SS           TRIM/SS           TRIM/SS           TRIM/SS           TRIM/SS           TRIM/SS           TM (Temperature Monitor)           Temperature Coefficient [a]         TM <sub>TC</sub> Temperature Full Range Accuracy [a]         TM <sub>ACC</sub> Drive Capability         I <sub>TM</sub> Thermal Sapecification           Junction Temperature Shutdown [a]         T <sub>MAX</sub> Junction Temperature Shutdown [a]         T <sub>MAX</sub> Junction-to-Case Thermal Impedance         θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C           Case-to-Ambient Thermal Impedance         θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C		150 10 10 10 1.235 10	1500	mV μs μs pF Hz V <sub>DC</sub> nF μF
Enable Delay Time       t <sub>EE</sub> Disable Delay Time       t <sub>ED</sub> Maximum Capacitance       C <sub>EC</sub> Maximum External Toggle Rate       f <sub>EXT</sub> TRIM/SS         TM (Temperature Monitor)         Temperature Coefficient [a]       TM <sub>TC</sub> Tomperature Full Range Accuracy [a]       TM <sub>ACC</sub> Drive Capability       I <sub>TM</sub> TM Output Setting       V <sub>TM</sub> Ambient Temperature = 300°K         Thermal Specification         Junction Temperature Shutdown [a]       T <sub>MAX</sub> Junction-to-Case Thermal Impedance       θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C         Case-to-Ambient Thermal Impedance       θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	_5	10 10 1.235 10	1	μs μs pF Hz V <sub>DC</sub> nF μF
Disable Delay Time       t <sub>ED</sub> Maximum Capacitance       C <sub>EC</sub> Maximum External Toggle Rate       f <sub>EXT</sub> TRIM/SS         TRIM/SS         Trim Voltage Reference       V <sub>REF</sub> Internal Capacitance       C <sub>REF</sub> External Capacitance       C <sub>REF</sub> Internal Resistance       R <sub>REFI</sub> TM (Temperature Monitor)         Temperature Coefficient [a]       TM <sub>TC</sub> Temperature Full Range Accuracy [a]       TM <sub>ACC</sub> Drive Capability       I <sub>TM</sub> TM Output Setting       V <sub>TM</sub> Ambient Temperature = 300°K         Thermal Specification         Junction Temperature Shutdown [a]       T <sub>MAX</sub> Junction-to-Case Thermal Impedance       θ <sub>J-C</sub> Case-to-Ambient Thermal Impedance       θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	_5	1.235 10	1	μs pF Hz V <sub>DC</sub> nF μF
Maximum Capacitance  Maximum External Toggle Rate  F <sub>EXT</sub> TRIM/SS  Trim Voltage Reference  V <sub>REF</sub> Internal Capacitance  External Capacitance  C <sub>REF</sub> Internal Resistance  R <sub>REFI</sub> TM (Temperature Monitor)  Temperature Coefficient [a]  TM <sub>TC</sub> Temperature Full Range Accuracy [a]  TM <sub>ACC</sub> Drive Capability  TM Output Setting  V <sub>TM</sub> Ambient Temperature = 300°K  Junction Temperature Shutdown [a]  Junction-to-Case Thermal Impedance  C <sub>BC</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C  Soldering	_5	1.235	1	pF Hz V <sub>DC</sub> nF μF
Maximum External Toggle Rate       f <sub>EXT</sub> TRIM/SS         Trim Voltage Reference       V <sub>REF</sub> Internal Capacitance       C <sub>REFI</sub> External Capacitance       C <sub>REFI</sub> Internal Resistance       TM (Temperature Monitor)         TM (Temperature Monitor)         Temperature Coefficient [a]       TM <sub>TC</sub> Temperature Full Range Accuracy [a]       TM <sub>ACC</sub> Drive Capability       I <sub>TM</sub> TM Output Setting       V <sub>TM</sub> Ambient Temperature = 300°K         Thermal Specification         Junction Temperature Shutdown [a]       T <sub>MAX</sub> Junction-to-Case Thermal Impedance       θ <sub>J-C</sub> Case-to-Ambient Thermal Impedance       θ <sub>C-A</sub> Mounted on 9in² 1 oz. Cu 6 layer PCB 25°C         Soldering	_5	10	1	Hz V <sub>DC</sub> nF μF
	_5	10		V <sub>DC</sub> nF μF
Trim Voltage Reference V <sub>REF</sub> Internal Capacitance C <sub>REFI</sub> External Capacitance C <sub>REFI</sub> Internal Resistance R <sub>REFI</sub> Internal Resistance TM (Temperature Monitor)  Temperature Coefficient [a] TM <sub>TC</sub> Temperature Full Range Accuracy [a] TM <sub>ACC</sub> Drive Capability I <sub>TM</sub> TM Output Setting V <sub>TM</sub> Ambient Temperature = 300°K  Thermal Specification  Junction Temperature Shutdown [a] T <sub>MAX</sub> Junction-to-Case Thermal Impedance θ <sub>J-C</sub> Case-to-Ambient Thermal Impedance θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	_5	10	0.22	nF µF
Trim Voltage Reference V <sub>REF</sub> Internal Capacitance C <sub>REFI</sub> External Capacitance C <sub>REFI</sub> Internal Resistance R <sub>REFI</sub> Internal Resistance TM (Temperature Monitor)  Temperature Coefficient [a] TM <sub>TC</sub> Temperature Full Range Accuracy [a] TM <sub>ACC</sub> Drive Capability I <sub>TM</sub> TM Output Setting V <sub>TM</sub> Ambient Temperature = 300°K  Junction Temperature Shutdown [a] T <sub>MAX</sub> Junction-to-Case Thermal Impedance θ <sub>J-C</sub> Case-to-Ambient Thermal Impedance θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	_5	10	0.22	nF µF
$ \begin{array}{ c c c c } \hline \text{Internal Capacitance} & C_{\text{REF}} \\ \hline \text{External Capacitance} & C_{\text{REF}} \\ \hline \\ \hline \text{Internal Resistance} & R_{\text{REFI}} \\ \hline \\$	-5	10	0.22	nF µF
External Capacitance    Capacitance   Capacitance   Rate	_5	10	0.22	μF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	_5		0.22	
	_5			K12
Temperature Coefficient [a] $TM_{TC}$ Temperature Full Range Accuracy [a] $TM_{ACC}$ Drive Capability $I_{TM}$ TM Output Setting $V_{TM}$ Ambient Temperature = 300°K  Thermal Specification  Junction Temperature Shutdown [a] $T_{MAX}$ Junction-to-Case Thermal Impedance $\theta_{J-C}$ Case-to-Ambient Thermal Impedance $\theta_{C-A}$ Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	_5			
Temperature Full Range Accuracy [a] $TM_{ACC}$ Drive Capability $I_{TM}$ TM Output Setting $V_{TM}$ Ambient Temperature = 300°K  Thermal Specification  Junction Temperature Shutdown [a] $T_{MAX}$ Junction-to-Case Thermal Impedance $\theta_{J-C}$ Case-to-Ambient Thermal Impedance $\theta_{C-A}$ Mounted on 9in² 1oz. Cu 6 layer PCB 25°C	_5			
	_5	10		mV/°K
TM Output Setting $V_{TM}$ Ambient Temperature = 300°K	-5		5	°K
	-100			μΑ
		3.00		V
Junction Temperature Shutdown [a] $T_{MAX}$ Junction-to-Case Thermal Impedance $\theta_{J-C}$ Case-to-Ambient Thermal Impedance $\theta_{C-A}$ Mounted on 9in² 1oz. Cu 6 layer PCB 25°C    Soldering				
Junction-to-Case Thermal Impedance $\theta_{J-C}$ Case-to-Ambient Thermal Impedance $\theta_{C-A}$ Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C  Soldering	130	135	140	°C
Case-to-Ambient Thermal Impedance θ <sub>C-A</sub> Mounted on 9in² 1oz. Cu 6 layer PCB 25°C  Soldering		3		°C/W
_		7.6		°C/W
_				
Peak Temperature During Reflow  MSL 5; time on floor = 48 hours			225	°C
MSL 6; time on floor = 4 hours			245	°C
Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)				
EN 60950-1:2006				
IEC 61000-4-2				
UL60950-1:2007				
CAN/CSA C22.2 NO. 60950-1-07				
Recommended Input Fuse Rating I <sub>FUSE</sub> Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



### PI3105-00-HVIZ Electrical Characteristics (Cont.)

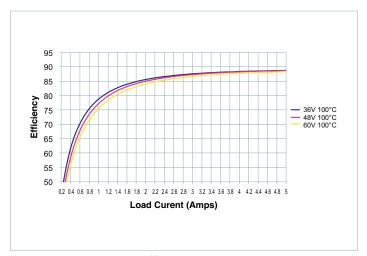


Figure 11 — Conversion efficiency

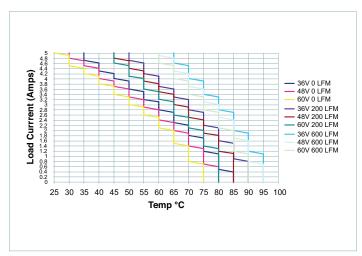


Figure 12 — Load currrent vs. temperature (without heat sink)

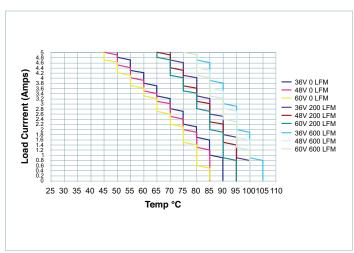
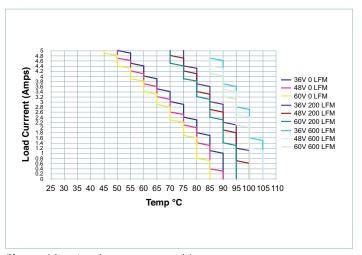
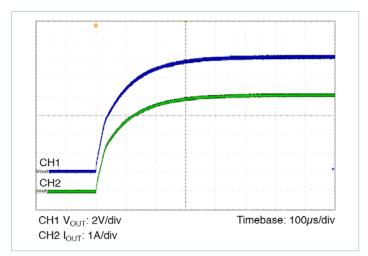


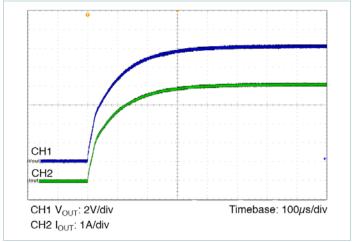
Figure 13 — Load currrent vs. temperature (6.3mm heat sink)



**Figure 14** — Load currrent vs. ambient temperature (11mm heat sink)

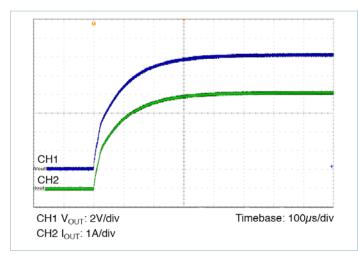


**Figure 15** — Start up  $C_{REF} = 0$  ( $V_{IN} = 36V$ ,  $I_{OUT} = 5A$ , CR,  $C_{OUT} = 6 \times 4.7 \mu F$  X7R ceramic)

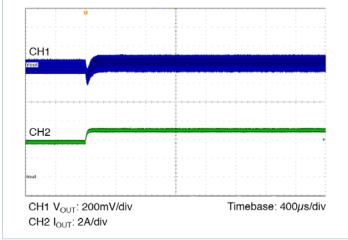


**Figure 16** — Start up  $C_{REF} = 0$  ( $V_{IN} = 48V$ ,  $I_{OUT} = 5A$ , CR,  $C_{OUT} = 6 \times 4.7 \mu F$  X7R ceramic)

# PI3105-00-HVIZ Electrical Characteristics (Cont.)



**Figure 17** — Start up  $C_{REF} = 0$  ( $V_{IN} = 75V$ ,  $I_{OUT} = 5A$ , CR,  $C_{OUT} = 6 \times 4.7 \mu F X7R$  ceramic)



**Figure 18** — Transient response ( $V_{IN} = 48V$ ,  $I_{OUT} = 3.75 - 5A$ ,  $0.1A/\mu s$ ,  $C_{OUT} = 6 \times 4.7 \mu F$  X7R ceramic)

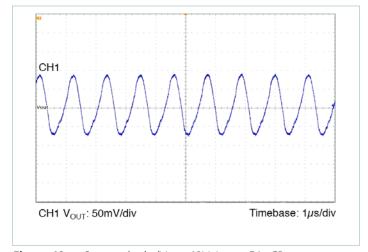


Figure 19 — Output ripple ( $V_{IN} = 48V$ ,  $I_{OUT} = 5A$ , CR,  $C_{OUT} = 6 \times 4.7 \mu F X7R$  ceramic)



**Figure 20** — Thermal image ( $V_{IN} = 48V$ ,  $I_{OUT} = 5A$ , CR, OLFM evaluation PCB)

## **PI3110-01-HVIZ Electrical Characteristics**

Unless otherwise specified: 41V <  $V_{IN}$  < 57V, 0A <  $I_{OUT}$  < 3.3A,  $-0^{\circ}C$  <  $T_{CASE}$  < 100°C  $^{[a]}$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V <sub>IN</sub>	рисорошнально	41	52	57	V <sub>DC</sub>
Input dV/dt [a]	V <sub>INDVDT</sub>	$V_{IN} = 57V$			1.0	V/µs
Input Undervoltage Turn-on	V <sub>UVON</sub>	$I_0 = 3.3A$	37.1	38.6	40.2	V <sub>DC</sub>
Input Undervoltage Turn-off	V <sub>UVOFF</sub>	I <sub>O</sub> = 3.3A	34.5	36.2	38	V <sub>DC</sub>
Input Undervoltage Hysteresis	V <sub>UVH</sub>	I <sub>O</sub> = 3.3A		2.4		V <sub>DC</sub>
Input Overvoltage Turn-on	V <sub>OVON</sub>	I <sub>O</sub> = 3.3A	57.5	60	62.5	V <sub>DC</sub>
Input Overvoltage Turn-off	V <sub>OVOFF</sub>	I <sub>O</sub> = 3.3A	59	61.3	63.5	V <sub>DC</sub>
Input Overvoltage Hysteresis	V <sub>OVH</sub>	I <sub>O</sub> = 3.3A		1.3		V <sub>DC</sub>
Input Quiescent Current	I <sub>Q</sub>	$V_{\text{IN}} = 52V$ , ENABLE = 0V		2.5		mA <sub>DC</sub>
Input Idling Power	P <sub>IDLE</sub>	$V_{\text{IN}} = 52V, I_{\text{OUT}} = 0A$		3.3		W
Input Standby Power	P <sub>SBY</sub>	$V_{IN} = 52V$ , ENABLE = 0V		0.130		W
Input Current Full Load	I <sub>IN</sub>	$T_{CASE} = 100^{\circ}\text{C}$ , $I_{OUT} = 3.3\text{A}$ , $\eta_{FL} = 89\%$ typical, $V_{IN} = 52\text{V}$		1.28		A <sub>DC</sub>
Input Reflected Ripple Current	I <sub>INRR</sub>	$L_{\text{IN}} = 2\mu\text{H}$ $C_{\text{IN}} = 47\mu\text{F}$ 100V electrolytic + 2 x 1 $\mu$ F 100V X7R ceramic		20		mApp
Recommended Ext Input Capacitance	C <sub>IN</sub>	$C_{IN} = 47 \mu F$ 100V electrolytic + 2 x 1 $\mu F$ 100V X7R ceramic $C_{IN} = Cbulk + Chf$		49		μF
		Output Specifications				
Output Voltage Set Point	V <sub>OUT</sub>	I <sub>OUT</sub> = 1.65A		18		V <sub>DC</sub>
Total Output Accuracy	V <sub>OA</sub>	-0°C < T <sub>CASE</sub> < 100°C	-3		+3	%
Output Voltage Trim Range	V <sub>OADJ</sub>		-10		10	%
Output Current Range	I <sub>OUT</sub>				3.3	A <sub>DC</sub>
Overcurrent Protection	I <sub>OCP</sub>		3.8	5.8	9	A <sub>DC</sub>
Efficiency – Full Load	$\eta_{_{Fl}}$	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 52V	87.0	89.0		%
Efficiency – Half Load	$\eta_{HL}$	T <sub>CASE</sub> = 100°C, V <sub>IN</sub> = 52V	84.0	86.0		%
Output OVP Set Point	V <sub>OVP</sub>		21.7	22.5	23.3	V <sub>DC</sub>
Output Ripple Voltage	$V_{ORPP}$	C <sub>OUT</sub> = 6 x 2.2µF 25V X7R DC-20MHz		275		mVpp
Switching Frequency	f <sub>SW</sub>			900		kHz
Output Turn-on Delay Time	t <sub>ONDLY</sub>	$V_{IN} = V_{UVON}$ to ENABLE = 5V		80		ms
Output Turn-off Delay Time	t <sub>OFFDLY</sub>	V <sub>IN</sub> = V <sub>UVOFF</sub> to ENABLE < 1.8V		10		μs
Soft-Start Ramp Time	t <sub>ss</sub>	ENABLE = 5V to 90% V <sub>OUT</sub> C <sub>REF</sub> = 0		230		μs
Maximum Load Capacitance	C <sub>OUT</sub>	$C_{REF} = 0.68 \mu F$ , $C_{OUT} = Al$ Electrolytic			220	μF
Load Transient Deviation	V <sub>ODV</sub>	$I_{OUT} = 50\%$ step 0.1A/ $\mu$ S $C_{OUT} = 6 \times 2.2 \mu$ F 25V X7R		360		mV
Load Transient Recovery Time	t <sub>OVR</sub>	$I_{OUT} = 50\%$ step $0.1A/\mu S$ $C_{OUT} = 6 \times 2.2 \mu F$ 25V X7R $V_{OUT} \le 1\%$		100		μs
Maximum Output Power	P <sub>OUT</sub>			60		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 24.5V <sub>DC</sub>				
Continuous Output Current		4.2A <sub>DC</sub>				
Peak Output Current		12A <sub>DC</sub>				

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



<sup>[</sup>b] Current flow sourced by a pin has a negative sign.

# PI3110-01-HVIZ Electrical Characteristics (Cont.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		ENABLE				
DC Voltage Reference Output	V <sub>ERO</sub>	ENABLE	4.65	4.9	5.15	V <sub>DC</sub>
Output Current Limit [b]		ENABLE = 3.3V	-3.3	-2.6	-1.9	
Start Up Current Limit [b]	I <sub>ECL</sub>	ENABLE = 1V	-3.3 -120	-2.0 -90	-60	mA <sub>DC</sub> μΑ
Module Enable Voltage	I <sub>ESL</sub>	ENABLE = IV				
	V <sub>EME</sub>		1.95	2.5	3.05	V <sub>DC</sub>
Module Disable Voltage	V <sub>EMD</sub>		1.8	2.35	2.9	V <sub>DC</sub>
Disable Hysteresis	V <sub>EDH</sub>			150		mV
Enable Delay Time	t <sub>EE</sub>			10		μs
Disable Delay Time	t <sub>ED</sub>			10		μs
Maximum Capacitance	C <sub>EC</sub>				1500	pF
Maximum External Toggle Rate	f <sub>EXT</sub>				1	Hz
		TRIM/SS				
Trim Voltage Reference	$V_{REF}$			1.23		V <sub>DC</sub>
Internal Capacitance	C <sub>REFI</sub>			10		nF
External Capacitance	C <sub>REF</sub>				0.68	μF
Internal Resistance	R <sub>REFI</sub>			10		kΩ
The first test server to the first test server test server to the first test server test server to the first test server tes	· ·KEFI					1132
		TM (Temperature Monitor)				
Temperature Coefficient [a]	TM <sub>TC</sub>			10		mV/°K
Temperature Full Range Accuracy [a]	TM <sub>ACC</sub>		-5		5	°K
Drive Capability	I <sub>TM</sub>		-100			μΑ
TM Output Setting	V <sub>TM</sub>	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temporature Chutdous [a]	т	Inermal Specification	120	125	1.40	°C
Junction Temperature Shutdown [a]	T <sub>MAX</sub>		130	135	140	°CW
Junction-to-Case Thermal Impedance	θ <sub>J-C</sub>	24 6 6 6 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7		3		
Case-to-Ambient Thermal Impedance	θ <sub>C-A</sub>	Mounted on 9in <sup>2</sup> 1oz. Cu 6 layer PCB 25°C		11		°C/W
		Soldering				
		MSL 5; time on floor = 48 hours			225	°C
Peak Temperature During Reflow		MSL 6; time on floor = 4 hours			245	°C
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I <sub>FUSE</sub>	Fast acting LITTLEFUSE Nano <sup>2</sup> Series Fuse	4		10	А

<sup>[</sup>a] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.

[b] Current flow sourced by a pin has a negative sign.



### PI3110-01-HVIZ Electrical Characteristics (Cont.)

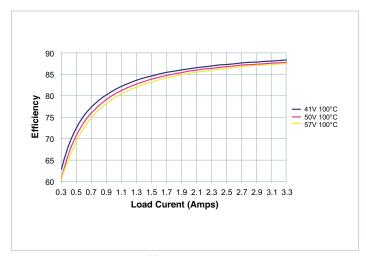


Figure 21 — Conversion efficiency

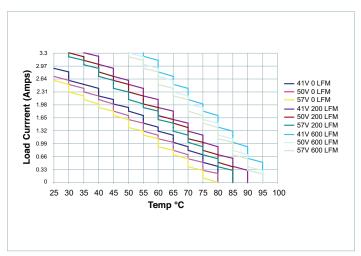


Figure 22 — Load currrent vs. temperature (without heat sink)

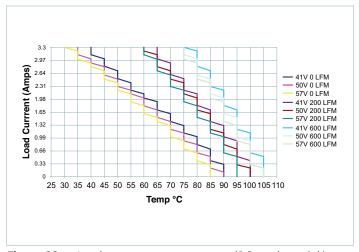
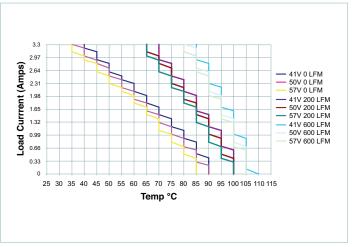
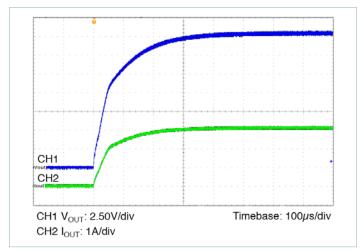


Figure 23 — Load currrent vs. temperature (6.3mm heat sink)



**Figure 24** — Load currrent vs. ambient temperature (11mm heat sink)



**Figure 25** — Start up  $C_{REF} = 0$  ( $V_{IN} = 41V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)

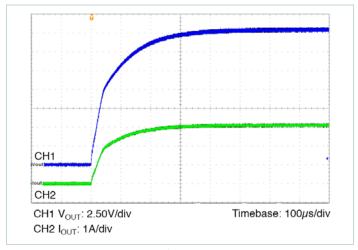
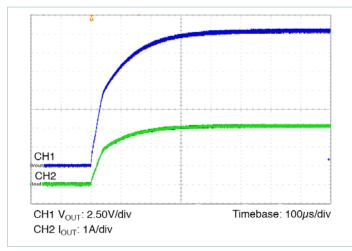
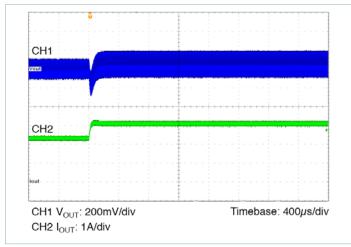


Figure 26 — Start up  $C_{REF} = 0$  ( $V_{IN} = 52V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)

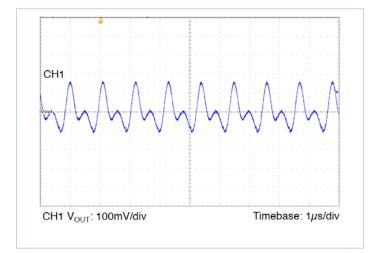
## PI3110-01-HVIZ Electrical Characteristics (Cont.)



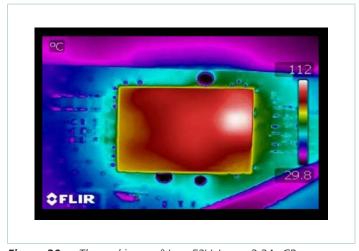
**Figure 27** — Start up  $C_{REF} = 0$  ( $V_{IN} = 57V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)



**Figure 28** — Transient response ( $V_{IN} = 52V$ ,  $I_{OUT} = 2.475 - 3.3A$ ,  $0.1A/\mu s$ ,  $C_{OUT} = 6 \times 2.2 \mu F$  X7R ceramic)

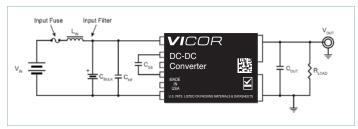


**Figure 29** — Output ripple ( $V_{IN} = 52V$ ,  $I_{OUT} = 3.3A$ , CR,  $C_{OUT} = 6 \times 2.2 \mu F X7R$  ceramic)



**Figure 30** — Thermal image ( $V_{IN} = 52V$ ,  $I_{OUT} = 3.3A$ , CR, OLFM evaluation PCB)

## **Functional Description**



**Figure 31** — 48 Volt Pl31xx shown with system fuse, filter, decoupling and extended soft start

#### Input Power Pins IN(+) and IN(-)

The input power pins on the 48 Volt PI31xx are connected to the input power source which can range from  $36 - 75V_{DC}$ . (PI3110-01-HVIZ 41 - 57V) Under surge conditions, the 48 Volt PI31xx can with stand up to 100V  $_{\rm DC}.$  (PI3110-01-HVIZ 80V) for 100ms without incurring damage. The user should take care to avoid driving the input rails above the specified ratings. Since the 48 Volt PI31xx is designed with high reliability in mind, the input pins are continuously monitored. If the applied voltage exceeds the input overvoltage trip point the conversion process shall be terminated immediately. The converter initiates soft start automatically within 80ms after the input voltage is reduced back to the appropriate value. The input pins do not have reverse-polarity protection. If the 48 Volt PI31xx is operated in an environment where reverse polarity is a concern, the user should consider using a polarity protection device such as a suitably rated diode. To avoid the high losses of using a diode, the user should consider the much higher efficiency family of intelligent Cool-ORing® solutions that can be used in reverse-polarity applications. Information is available at vicorpower.com.

The 48 Volt PI31xx will draw nearly zero current until the input voltage reaches the internal start up threshold. If the ENABLE pin is not pulled low by external circuitry, the output voltage will begin rising to its final output value about 80ms after the input UV lockout releases. This will occur automatically even if the ENABLE pin is floating.

To help keep the source impedance low, the input to the 48 Volt PI31xx should be bypassed with (2) 1.0 $\mu$ F 100V ceramic capacitors of X7R dielectric in parallel with a low Q 47 $\mu$ F 100V electrolytic capacitor. To reduce EMI and reflected ripple current, a series inductor of 0.2 – 0.47 $\mu$ H can be added. The input traces to the module should be low impedance configured in such a manner as to keep stray inductance minimized.

#### **ENABLE**

The ENABLE pin serves as a multi-function pin for the 48 Volt PI31xx. During normal operation, it outputs the on-board 4.9V regulator which can be used for trimming the module up. The ENABLE pin can also be used as a remote enable pin either from the secondary via an optocoupler and some external isolated bias supply or from the primary side through a small-signal transistor, FET or any device that sinks 3.3mA, minimum. If the ENABLE pin is lower than 2.35V typical, the converter will be held off or shut down if already operating. A third feature is offered in that during a fault condition such as output OVP, input UV or OV, or output current limit, the ENABLE pin is pulled low internally. This can be used as a signal to the user that a fault has occurred.

Whenever the ENABLE pin is pulled low, the TRIM/SS pin follows, resetting the internal and external soft-start circuitry. All faults will pull ENABLE low including overtemperature. If increased turn-on delay is desired, the ENABLE pin can be bypassed with a small capacitor up to a maximum of 1500pF.

#### TRIM/SS Pin

The TRIM/SS pin serves as another multi-purpose pin. First, it is used as the reference for the internal error amplifier. Connecting a resistor from TRIM/SS to SGND allows the reference to be margined down by as much as -20%. Connecting a resistor from TRIM/ SS to ENABLE will allow the reference and output voltage to be margined up by 10%. If the user wishes a longer start up time, a small ceramic capacitor can be added to TRIM/SS to increase it. It is critical to connect any device between TRIM/SS and SGND and not -IN, otherwise high frequency noise will be introduced to the reference and possibly cause erratic operation. Referring to the figures below, the appropriate trim-up or trim-down resistor can be calculated using the equivalent circuit diagram and the equations. When trimming up the trim-down resistor is not populated and when trimming down, the trim-up resistor is not populated. The soft-start time is adjustable and has a default value of 500µs to reach steady state. The internal soft-start capacitor value is 10nF.

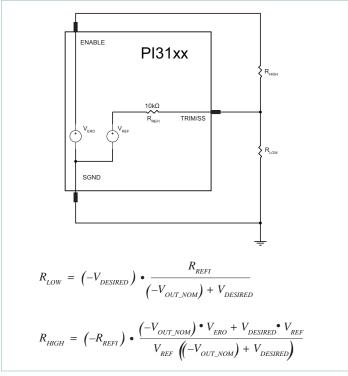


Figure 32 — Trim equations and equivalent circuit

$$C_{REF} = \frac{T_{SS\_DESIRED} - 230 \cdot 10^{-6}}{23000}$$

#### TM

The TM pin serves as an output indicator of the internal package temperature which is within ±5°K of the hottest junction temperature. Because of this, it is a good indicator of a thermal overload condition. The output is a scaled, buffered analog voltage which indicates the internal temperature in degrees Kelvin. Upon a thermal overload, the TM pin is pulled low, indicating a thermal fault has occurred. Upon restart of the converter, the TM pin reverts back to a buffered monitor. The thermal shutdown function of the 48 Volt PI31xx is a fault feature which interrupts power processing if a certain maximum temperature is exceeded. TM can be monitored by an external microcontroller or circuit configured as an adaptive fan speed controller so that air flow in the system can be conveniently regulated.

#### **SGND**

The 48 Volt PI31xx SGND pin is the "quiet" control circuitry return. It is basically an extension of the internal signal ground. To avoid contamination and potential ground loops, this ground should NOT be connected to –IN since it is already star connected inside the package. Connect signal logic to SGND.

#### Output Power Pins +OUT and -OUT

The output power terminals OUT(+) and OUT(-) deliver the maximum output current from the 48 Volt PI31xx through the J-lead output pins. This configuration allows for a low impedance output and should be connected to multi-layer PCB parallel planes for best performance. Due to the high switching frequency, output ripple and noise can be easily attenuated by adding just a few high-quality X7R ceramic capacitors while retaining adequate transient response for most applications. The 48 Volt PI31xx does not require any feedback loop compensation nor does it require any opto-isolation. All isolation is contained within the package. This greatly simplifies the use of the converter and eliminates all outside influences of noise on the quality of the output voltage regulation and feedback loop. It is important for the user to minimize resistive connections from the load to the converter output and to keep stray inductance to a minimum for best regulation and transient response. The very small size footprint and height of the 48 Volt PI31xx allows the converter to be placed in the optimum location to allow for tight connections to the point-of-load.



## **Package Outline & Recommended PCB Land Pattern**

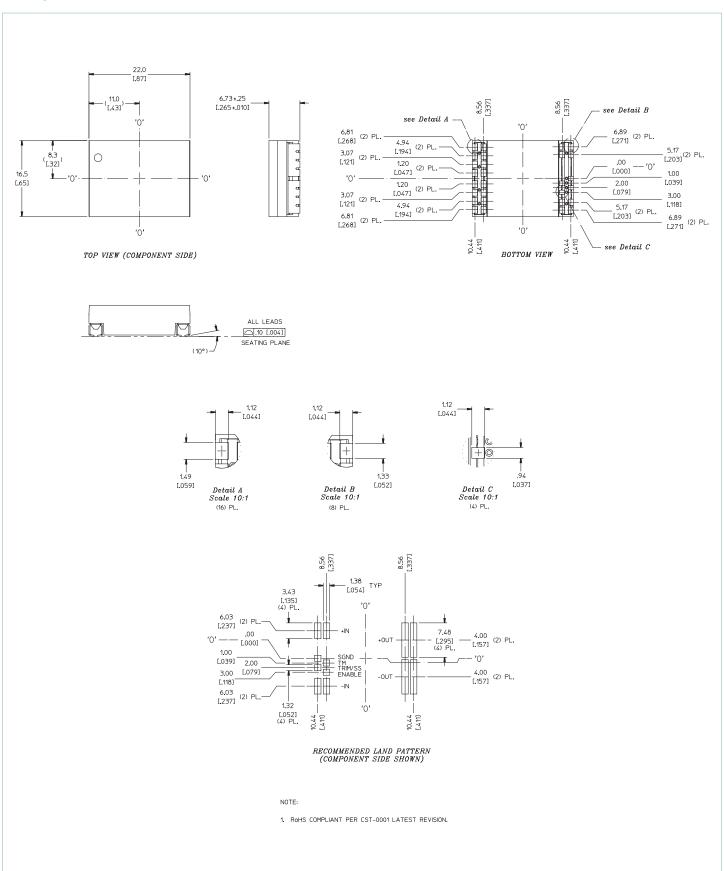


Figure 33 — Package outline & recommended PCB land pattern

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